

# *i*Coupler® Digital Isolator

## ADuM1100

#### **FEATURES**

High Data Rate: DC to 100 Mbps (NRZ) Compatible with 3.3 V and 5.0 V Operation/

**Level Translation** 

125°C Max Operating Temperature

**Low Power Operation** 

5 V Operation

1.0 mA Max @ 1 Mbps 4.5 mA Max @ 25 Mbps

16.8 mA Max @ 100 Mbps

3.3 V Operation

0.4 mA Max @ 1 Mbps

3.5 mA Max @ 25 Mbps

7.1 mA Max @ 50 Mbps

8-Lead SOIC Package (lead-free version available) High Common-Mode Transient Immunity: >25 kV/μs Safety and Regulatory Information

**UL Recognized** 

2500 V rms for 1 Minute per UL 1577

CSA Component Acceptance Notice No. 5A

**VDE Certificate of Conformity** 

DIN EN 60747-5-2 (VDE 0884 Part 2): 2003-01

DIN EN 60950 (VDE 0805): 2001-12; EN 60950: 2000

 $V_{IORM} = 560 V_{PEAK}$ 

### **GENERAL DESCRIPTION**

The ADuM1100 is a digital isolator based on Analog Devices' iCoupler technology. Combining high speed CMOS and monolithic air core transformer technology, this isolation component provides outstanding performance characteristics superior to alternatives such as optocoupler devices.

Configured as a pin compatible replacement for existing high speed optocouplers, the ADuM1100 supports data rates as high as 25 Mbps and 100 Mbps.

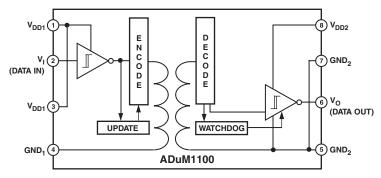
The ADuM1100 operates with either voltage supply ranging from 3.0 V to 5.5 V, boasts a propagation delay of <18 ns and edge asymmetry of <2 ns, and is compatible with temperatures up to 125°C. It operates at very low power, less than 0.9 mA of quiescent current (sum of both sides), and a dynamic current of less than 160 µA per Mbps of data rate. Unlike other optocoupler alternatives, the ADuM1100 provides dc correctness with a patented refresh feature that continuously updates the output signal.

The ADuM1100 is offered in three grades. The ADuM1100AR and ADuM1100BR can operate up to a maximum temperature of 105°C and support data rates up to 25 Mbps and 100 Mbps, respectively. The ADuM1100UR can operate up to a maximum temperature of 125°C and supports data rates up to 100 Mbps.

#### **APPLICATIONS**

**Digital Fieldbus Isolation Opto-Isolator Replacement Computer-Peripheral Interface** Microprocessor System Interface **General Instrumentation and Data Acquisition Applications** 

#### FUNCTIONAL BLOCK DIAGRAM



FOR PRINCIPLES OF OPERATION, SEE METHOD OF OPERATION, DC CORRECTNESS, AND MAGNETIC FIELD IMMUNITY SECTION.

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# ADuM1100-SPECIFICATIONS

# **ELECTRICAL SPECIFICATIONS, 5 V OPERATION** $(4.5 \text{ V} \leq \text{V}_{DD} \text{ specification}$ range, unless otherwise noted. All typical specifications are at $T_A = 25^{\circ}\text{C}$ , $V_{DD1} = V_{DD2} = 5 \text{ V}$ .)

(4.5 V  $\leq$  V<sub>DD1</sub>  $\leq$  5.5 V, 4.5 V  $\leq$  V<sub>DD2</sub>  $\leq$  5.5 V. All min/max specifications apply over the entire recommended operation = V<sub>DD2</sub> = 5 V )

Parameter	Symbol	Min	Typ	Max	Unit	<b>Test Conditions</b>
DC SPECIFICATIONS						
Input Supply Current	$I_{\mathrm{DD1(Q)}}$		0.3	0.8	mA	$V_I = 0 \text{ V or } V_{DD1}$
Output Supply Current	$I_{DD2(Q)}$		0.01	0.06	mA	$V_I = 0 \text{ V or } V_{DD1}$
Input Supply Current (25 Mbps)	$I_{\mathrm{DD1(25)}}$		2.2	3.5	mA	12.5 MHz Logic Signal Frequency
(See TPC 1)						
Output Supply Current <sup>2</sup> (25 Mbps) (See TPC 2)	$I_{DD2(25)}$		0.5	1.0	mA	12.5 MHz Logic Signal Frequency
Input Supply Current (100 Mbps) (See TPC 1)	$I_{\mathrm{DD1(100)}}$		9.0	14	mA	50 MHz Logic Signal Frequency, ADuM1100BR/ADuM1100UR Only
Output Supply Current <sup>2</sup> (100 Mbps) (See TPC 2)	$I_{\mathrm{DD2(100)}}$		2.0	2.8	mA	50 MHz Logic Signal Frequency, ADuM1100BR/ADuM1100UR Only
Input Current	$I_{I}$	-10	+0.01	+10	μA	$0 \le V_{IN} \le V_{DD1}$
Logic High Output Voltage	$V_{OH}$	$V_{\rm DD2} - 0.1$			V	$I_O = -20 \mu A, V_I = V_{IH}$
	011	$V_{\rm DD2} - 0.8$			V	$I_O = -4 \text{ mA}, V_I = V_{IH}$
Logic Low Output Voltage	$V_{OL}$	BB2	0.0	0.1	V	$I_{O} = 20  \mu A, V_{I} = V_{IL}$
	OL		0.03	0.1	V	$I_O = 400 \mu\text{A},  V_I = V_{IL}$
			0.3	0.8	V	$I_O = 4 \text{ mÅ}, V_I = V_{IL}$
SWITCHING SPECIFICATIONS						
For ADuM1100AR						
Minimum Pulse Width <sup>3</sup>	PW			40	ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Maximum Data Rate <sup>4</sup>	1	25		10	Mbps	$C_L = 15 \text{ pF}, \text{ CMOS Signal Levels}$
For ADuM1100BR/ADuM1100UR					TVIOP5	or 13 pr, civies signal zevels
Minimum Pulse Width <sup>3</sup>	PW		6.7	10	ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Maximum Data Rate <sup>4</sup>	1	100	150	10	Mbps	$C_L = 15 \text{ pF}, \text{ CMOS Signal Levels}$
For All Grades		100	130		1110ps	CL 13 p1, Clives Signal Levels
Propagation Delay Time to Logic Low Output <sup>5, 6</sup>	t <sub>PHL</sub>		10.5	18	ns	$C_L$ = 15 pF, CMOS Signal Levels
(See TPC 3)						
Propagation Delay Time to Logic High Output <sup>5, 6</sup>	t <sub>PLH</sub>		10.5	18	ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
(See TPC 3)						
Pulse Width Distortion   t <sub>PLH</sub> - t <sub>PHL</sub>   6	PWD		0.5	2	ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Change versus Temperature <sup>7</sup>			3		ps/°C	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Propagation Delay Skew (Equal Temperature) <sup>6, 8</sup>	t <sub>PSK1</sub>			8	ns	$C_L$ = 15 pF, CMOS Signal Levels
Propagation Delay Skew (Equal Temperature, Supplies) <sup>6, 8</sup>	t <sub>PSK2</sub>			6	ns	$C_L$ = 15 pF, CMOS Signal Levels
Output Rise/Fall Time	$t_R, t_F$		3		ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Common-Mode Transient Immunity	$ CM_L $	25	35		kV/μs	$V_{\rm I} = 0 \text{ or } V_{\rm DD1}, V_{\rm CM} = 1000 \text{ V},$
at Logic Low/High Output9	$ CM_H $					Transient Magnitude = 800 V
Input Dynamic Power	$C_{PD1}$		35		pF	
Dissipation Capacitance <sup>10</sup>	121				1	
Output Dynamic Power	$C_{PD2}$		8		pF	
Dissipation Capacitance <sup>10</sup>	1104				1	

See Notes on page 5.

Specifications subject to change without notice.

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# **ELECTRICAL SPECIFICATIONS, 3.3 V OPERATION** $(3.0 \text{ V} \leq \text{V}_{DD1} \leq 3.6 \text{ V}, 3.0 \text{ V} \leq \text{V}_{DD2} \leq 3.6 \text{ V}. \text{ All min/max}$ range, unless otherwise noted. All typical specifications are at $T_A = 25^{\circ}\text{C}$ , $V_{DD1} = V_{DD2} = 3.3 \text{ V}$ .)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Input Supply Current	$I_{\mathrm{DD1(Q)}}$		0.1	0.3	mA	$V_{I} = 0 \text{ V or } V_{DD1}$
Output Supply Current	$I_{\mathrm{DD2(Q)}}$		0.005		mA	$V_{I} = 0 \text{ V or } V_{DD1}$
Input Supply Current (25 Mbps)	$I_{\mathrm{DD1(25)}}$		2.0	2.8	mA	12.5 MHz Logic Signal Frequency
(See TPC 1)	DD1(23)					
Output Supply Current <sup>2</sup> (25 Mbps)	$I_{\mathrm{DD2(25)}}$		0.3	0.7	mA	12.5 MHz Logic Signal Frequency
(See TPC 2)						
Input Supply Current (50 Mbps) (See TPC 1)	$I_{\mathrm{DD1(50)}}$		4.0	6.0	mA	25 MHz Logic Signal Frequency, ADuM1100BR/ADuM1100UR Only
Output Supply Current <sup>2</sup> (50 Mbps)	$I_{\mathrm{DD2(50)}}$		1.2	1.6	mA	25 MHz Logic Signal Frequency,
(See TPC 2)	*DD2(50)		1.2	1.0	11111	ADuM1100BR/ADuM1100UR Only
Input Current	$I_{\rm I}$	-10	+0.01	+10	μA	$0 \le V_{\rm IN} \le V_{\rm DD1}$
Logic High Output Voltage	V <sub>OH</sub>	$V_{DD2} - 0.1$			V	$I_O = -20 \mu A$ , $V_I = V_{IH}$
nogra ingli o alpat voltage	OH	$V_{DD2} - 0.5$			v	$I_O = -2.5 \text{ mA}, V_I = V_{IH}$
Logic Low Output Voltage	$V_{OL}$	1 002 013	0.0	0.1	v	$I_O = 20 \mu A, V_I = V_{IL}$
	OL		0.04	0.1	V	$I_O = 400 \mu\text{A},  V_I = V_{IL}$
			0.3	0.4	V	$I_{O} = 2.5 \text{ mA}, V_{I} = V_{IL}$
SWITCHING SPECIFICATIONS						
For ADuM1100AR						
Minimum Pulse Width <sup>3</sup>	PW			40	ns	C <sub>L</sub> = 15 pF, CMOS Signal Levels
Maximum Data Rate <sup>4</sup>	1 "	25		10	Mbps	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
For ADuM1100BR/ADuM1100UR		23			IVIOPS	or 13 pr, Givies signar Levels
Minimum Pulse Width <sup>3</sup>	PW		10	20	ns	C <sub>L</sub> = 15 pF, CMOS Signal Levels
Maximum Data Rate <sup>4</sup>	1 "	50	100	20	Mbps	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
For All Grades			100		1,1000	or 13 pr, civies signar zevels
Propagation Delay Time to	t <sub>PHL</sub>		14.5	28	ns	$C_L$ = 15 pF, CMOS Signal Levels
Logic Low Output <sup>5, 6</sup>	11112					
(See TPC 4)						
Propagation Delay Time to	t <sub>PLH</sub>		15.0	28	ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Logic High Output <sup>5, 6</sup>	1211					
(See TPC 4)						
Pulse Width Distortion $ t_{PLH} - t_{PHL} ^6$	PWD		0.5	3	ns	C <sub>L</sub> = 15 pF, CMOS Signal Levels
Change versus Temperature <sup>7</sup>			10		ps/°C	C <sub>L</sub> = 15 pF, CMOS Signal Levels
Propagation Delay Skew	t <sub>PSK1</sub>			15	ns	C <sub>L</sub> = 15 pF, CMOS Signal Levels
(Equal Temperature) <sup>6, 8</sup>	10111					
Propagation Delay Skew	t <sub>PSK2</sub>			12	ns	$C_L$ = 15 pF, CMOS Signal Levels
(Equal Temperature, Supplies) <sup>6, 8</sup>						
Output Rise/Fall Time	t <sub>R</sub> , t <sub>F</sub>		3		ns	$C_L$ = 15 pF, CMOS Signal Levels
Common-Mode Transient Immunity	$ CM_L $ ,	25	35		kV/μs	$V_{I} = 0 \text{ or } V_{DD1}, V_{CM} = 1000 \text{ V},$
at Logic Low/High Output <sup>9</sup>	$ CM_H $					Transient Magnitude = 800 V
Input Dynamic Power Dissipation	$C_{PD1}$		47		pF	_
Capacitance <sup>10</sup>	_				_	
Output Dynamic Power Dissipation	$C_{\mathrm{PD2}}$		14		pF	
Capacitance <sup>10</sup>						

See Notes on page 5.

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Specifications subject to change without notice.

**ELECTRICAL SPECIFICATIONS, MIXED 5 V/3 V or 3 V/5 V OPERATION**  $(5 \text{ V/3 V operation: } 4.5 \text{ V} \leq \text{V}_{DD1} \leq 5.5 \text{ V}, 3.0 \text{ V} \leq \text{V}_{DD2} \leq 3.6 \text{ V}.$   $3 \text{ V/5 V operation: } 3.0 \text{ V} \leq \text{V}_{DD1} \leq 3.6 \text{ V}, 4.5 \text{ V} \leq \text{V}_{DD2} \leq 5.5 \text{ V}. \text{ All min/max specifications apply over the entire recommended operation range, unless otherwise noted. All typical specifications are at T_A = 25°C, V_{DD1} = 3.3 \text{ V}, V_{DD2} = 5 \text{ V or V}_{DD1} = 5 \text{ V}, V_{DD2} = 3.3 \text{ V}.)$ 

Parameter	Symbol	Min	Тур	Max	Unit	Test Conditions
DC SPECIFICATIONS						
Input Supply Current, Quiescent	$I_{\mathrm{DDI}(\mathrm{Q})}$					
5 V/3 V Operation			0.3	0.8	mA	
3 V/5 V Operation			0.1	0.3	mA	
Output Supply Current, Quiescent	$I_{\mathrm{DDO}(\mathrm{Q})}$					
5 V/3 V Operation			0.005	0.04	mA	
3 V/5 V Operation			0.01	0.06	mA	
Input Supply Current, 25 Mbps	$I_{\mathrm{DDI}(25)}$					
5 V/3 V Operation			2.2	3.5	mA	12.5 MHz Logic Signal Frequency
3 V/5 V Operation	_		2.0	2.8	mA	12.5 MHz Logic Signal Frequency
Output Supply Current, 25 Mbps	$I_{\mathrm{DDO(25)}}$		0.2	0.7	A	10 5 MH- L Ci 1 E
5 V/3 V Operation 3 V/5 V Operation			0.3 0.5	$0.7 \\ 1.0$	mA mA	12.5 MHz Logic Signal Frequency 12.5 MHz Logic Signal Frequency
Input Supply Current, 50 Mbps	т		0.5	1.0	ША	12.5 MHz Logic Signal Frequency
5 V/3 V Operation	$I_{DDI(50)}$		4.5	7.0	mA	25 MHz Logic Signal Frequency
3 V/5 V Operation			4.0	6.0	mA	25 MHz Logic Signal Frequency
Output Supply Current, 50 Mbps	$I_{\mathrm{DDO}(50)}$		1.0	0.0	11111	25 Will 2 Logic Orginal Trequency
5 V/3 V Operation	<b>-</b> DDO(50)		1.2	1.6	mA	25 MHz Logic Signal Frequency
3 V/5 V Operation			1.0	1.5	mA	25 MHz Logic Signal Frequency
Input Currents	$I_{IA}$	-10	+0.01	+10	μΑ	$0 \le V_{IA}, V_{IB}, V_{IC}, V_{ID} \le V_{DD1}$ or $V_{DD2}$
Logic High Output Voltage,	V <sub>OH</sub>	$V_{\rm DD2} - 0.1$	3.3		V	$I_O = -20 \mu A$ , $V_I = V_{IH}$
5 V/3 V Operation		$V_{\rm DD2} - 0.5$			V	$I_{\rm O} = -2.5 \text{ mA}, V_{\rm I} = V_{\rm IH}$
Logic Low Output Voltage,	V <sub>OL</sub>		0.0	0.1	V	$I_O = 20 \mu A$ , $V_I = V_{IL}$
5 V/3 V Operation			0.04	0.1	V	$I_{O} = 400 \ \mu A, V_{I} = V_{IL}$
			0.3	0.4	V	$I_O = 2.5 \text{ mA}, V_I = V_{IL}$
Logic High Output Voltage,	V <sub>OH</sub>	$V_{DD2} - 0.1$			V	$I_{O} = -20 \mu A, V_{I} = V_{IH}$
3 V/5 V Operation	**	$V_{\rm DD2} - 0.8$		0.1	V	$I_O = -4 \text{ mA}, V_I = V_{IH}$
Logic Low Output Voltage,	$V_{OL}$		0.0	0.1	V V	$I_{O} = 20 \mu A, V_{I} = V_{IL}$
3 V/5 V Operation			0.03	0.1 0.8	V	$I_{O} = 400 \mu A, V_{I} = V_{IL}$ $I_{O} = 4 \text{ mA}, V_{I} = V_{IL}$
			0.5	0.0	v	10 - 4 ma, v <sub>1</sub> - v <sub>1L</sub>
SWITCHING SPECIFICATIONS For ADuM1100AR						
Minimum Pulse Width <sup>3</sup>	PW			40	***	C = 15 pE CMOS Signal Lavala
Maximum Data Rate <sup>4</sup>	I W	25		40	ns Mbps	$C_L = 15 \text{ pF}$ , CMOS Signal Levels $C_L = 15 \text{ pF}$ , CMOS Signal Levels
For ADuM1100BR/ADuM1100UR		23			Mops	CL = 15 pr, CiviO3 Signal Levels
Minimum Pulse Width <sup>3</sup>	PW			20	ns	C <sub>L</sub> = 15 pF, CMOS Signal Levels
Maximum Data Rate <sup>4</sup>	***	50		20	Mbps	
For All Grades						L P J S S S S S S S S S S S S S S S S S S
Propagation Delay Time to Logic	t <sub>PHL</sub> , t <sub>PLH</sub>					
Low/High Output <sup>5, 6</sup>						
5 V/3 V Operation (See TPC 5)			13	21	ns	$C_L$ = 15 pF, CMOS Signal Levels
3 V/5 V Operation (See TPC 6)			16	26	ns	$C_L$ = 15 pF, CMOS Signal Levels
Pulse Width Distortion, $ t_{PLH} - t_{PHL} ^6$	PWD					
5 V/3 V Operation			0.5	2	ns	$C_L$ = 15 pF, CMOS Signal Levels
3 V/5 V Operation			0.5	3	ns	$C_L$ = 15 pF, CMOS Signal Levels
Change versus Temperature					/0.0	
5 V/3 V Operation			3		ps/°C	C <sub>L</sub> = 15 pF, CMOS Signal Levels
3 V/5 V Operation			10		ps/°C	$C_L$ = 15 pF, CMOS Signal Levels
Propagation Delay Skew (Equal Temperature) <sup>6, 8</sup>	t <sub>PSK1</sub>					
5 V/3 V Operation				12	ne	C <sub>L</sub> = 15 pF, CMOS Signal Levels
3 V/5 V Operation				15	ns ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels $C_L = 15 \text{ pF}$ , CMOS Signal Levels
- Operation				1.7	113	OL 15 pr, Givioo digital Levels

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Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
SWITCHING SPECIFICATIONS (continued)						
Propagation Delay Skew	t <sub>PSK2</sub>					
(Equal Temperature, Supplies) <sup>6, 8</sup>						
5 V/3 V Operation				9	ns	$C_L$ = 15 pF, CMOS Signal Levels
3 V/5 V Operation				12	ns	$C_L = 15 \text{ pF}$ , CMOS Signal Levels
Output Rise/Fall Time (10% to 90%)	$t_R$ , $t_f$		3		ns	$C_L$ = 15 pF, CMOS Signal Levels
Common-Mode Transient Immunity at						
Logic Low/High Output <sup>8</sup>	$ CM_L $ ,	25	35		kV/μs	$V_{I} = 0 \text{ or } V_{DD1}, V_{CM} = 1000 \text{ V},$
	$ CM_H $					Transient Magnitude = 800 V
Input Dynamic Power Dissipation Capacitance <sup>10</sup>	$C_{PD1}$					
5 V/3 V Operation			35		pF	
3 V/5 V Operation			47		pF	
Output Dynamic Power Dissipation Capacitance <sup>10</sup>	$C_{PD2}$					
5 V/3 V Operation			8		pF	
3 V/5 V Operation			14		pF	

#### NOTES

#### PACKAGE CHARACTERISTICS

Parameter	Symbol	Min Typ	Max	Unit	Test Conditions
Resistance (Input-Output) <sup>1</sup>	$R_{I-O}$	$10^{12}$		Ω	
Capacitance (Input-Output) <sup>1</sup>	$C_{I-O}$	1		рF	f = 1  MHz
Input Capacitance <sup>2</sup>	$C_{\rm I}$	4.0		pF	
Input IC Junction-to-Case	$\theta_{ m JCI}$	46		°C/W	Thermocouple Located at Center
Thermal Resistance	,				Underside of Package
Output IC Junction-to-Case	$\theta_{\rm ICO}$	41		°C/W	
Thermal Resistance	3.1				
Package Power Dissipation	$P_{PD}$		240	mW	

#### NOTES

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<sup>&</sup>lt;sup>1</sup>All voltages are relative to their respective ground.

<sup>&</sup>lt;sup>2</sup>Output supply current values are with no output load present. The supply current drawn at a given signal frequency when an output load is present is given by  $I_{DD2(L)} = I_{DD2} + V_{DD2} \times f \times C_L$ , where  $I_{DD2}$  is the unloaded output supply current, f is the input signal frequency, and  $C_L$  is the output load capacitance.

<sup>&</sup>lt;sup>3</sup>The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is guaranteed.

<sup>&</sup>lt;sup>4</sup>The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.

 $<sup>^{5}</sup>t_{PHL}$  is measured from the 50% level of the falling edge of the  $V_{I}$  signal to the 50% level of the falling edge of the  $V_{O}$  signal.  $t_{PLH}$  is measured from the 50% level of the rising edge of the  $V_{I}$  signal to the 50% level of the rising edge of the  $V_{O}$  signal.

<sup>&</sup>lt;sup>6</sup>Since the input thresholds of the ADuM1100 are at voltages other than the 50% level of typical input signals, the measured propagation delay and pulse width distortion may be affected by slow input rise/fall times. See the Propagation Delay-Related Parameters section and Figures 3 to 7 for information on the impact of given input rise/fall times on these parameters.

<sup>&</sup>lt;sup>7</sup>Pulse width distortion change versus temperature is the absolute value of the change in pulse width distortion for a 1°C change in operating temperature.

 $<sup>^{8}</sup>$ t<sub>PSK1</sub> is the magnitude of the worst-case difference in t<sub>PHL</sub> and/or t<sub>PLH</sub> that will be measured between units at the same operating temperature and output load within the recommended operating conditions. t<sub>PSK2</sub> is the magnitude of the worst-case difference in t<sub>PHL</sub> and/or t<sub>PLH</sub> that will be measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.

 $<sup>^{9}</sup>$ CM<sub>H</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_{O} > 0.8 \text{ V}_{DD2}$ . CM<sub>L</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_{O} < 0.8 \text{ V}$ . The common-mode voltage slew rates apply to both rising and falling edges. The transient magnitude is the range over which the common-mode is slewed.

<sup>&</sup>lt;sup>10</sup>The dynamic power dissipation capacitance is given by

 $C_{PDi} = (I_{DDi(100)} - I_{DDi(Q)})/(V_{DDi} \times f)$ , where i = 1 or 2 and f is the input signal frequency.

The supply current consumptions at a given frequency and output load are calculated as

 $I_{DD1} = C_{PD1} \times V_{DD1} \times f + I_{DD1(Q)}; I_{DD2(L)} = (C_{PD2} + C_L) \times V_{DD2} \times f + I_{DD2(Q)}, \text{ where } C_L \text{ is the output load capacitance.}$ 

Specifications subject to change without notice.

<sup>&</sup>lt;sup>1</sup>Device considered a 2-terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7, and 8 shorted together.

 $<sup>^{2}</sup>$ Input capacitance is measured at Pin 2 (V<sub>I</sub>).

#### REGULATORY INFORMATION

The ADuM1100 has been approved by the following organizations:

UL	CSA	VDE
Recognized under 1577		Certified according to
Component Recognition Program <sup>1</sup>	Acceptance Notice No. 5A, C22.2 No. 1-98,	DIN EN 60747-5-2 (VDE 0884 Part 2): 2003–1 <sup>2</sup>
	C22.2 No. 14-95, and C22.2 No. 950-95	DIN EN 60950 (VDE 0805): 2001–12; EN60950: 2000
File E214100	File 205078	File 2471900-4880-0002

#### NOTES

#### INSULATION AND SAFETY-RELATED SPECIFICATIONS

Parameter	Symbol	Value	Unit	Conditions
Minimum External Air Gap (Clearance)	L(I01)	4.90 min	mm	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L(I02)	4.01 min	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum Internal Gap (Internal Clearance) Tracking Resistance (Comparative Tracking Index) Isolation Group	CTI	0.016 min >175 IIIa	mm V	Insulation distance through insulation DIN IEC 112/VDE 0303 Part 1 Material Group (DIN VDE 0110, 1/89, Table 1)

#### DIN EN 60747-5-2 (VDE 0884 Part 2) INSULATION CHARACTERISTICS

Description	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110			
For Rated Mains Voltage ≤ 150 V rms		I to IV	
For Rated Mains Voltage ≤ 300 V rms		I to III	
For Rated Mains Voltage ≤ 400 V rms		I to II	
Climatic Classification			
ADuM1100AR and ADuM1100BR		40/105/21	
ADuM1100UR		40/125/21	
Pollution Degree (DIN VDE 0110, Table I)		2	
Maximum Working Insulation Voltage	V <sub>IORM</sub>	560	$V_{PEAK}$
Input-to-Output Test Voltage, Method b1			
$V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test, $t_M = 1$ sec, Partial Discharge < 5 pC	$V_{PR}$	1050	$V_{PEAK}$
Input-to-Output Test Voltage, Method a	$V_{PR}$	672	$V_{PEAK}$
After Environmental Tests Subgroup 1			
$V_{IORM} \times 1.6 = V_{PR}$ , $t_M = 10$ sec, Partial Discharge < 5 pC	$V_{PR}$	896	$V_{PEAK}$
After Input and/or Output Safety Test Subgroup 2/3			
$V_{IORM} \times 1.2 = V_{PR}$ , $t_M = 10$ sec, Partial Discharge < 5 pC	$V_{PR}$	672	$V_{PEAK}$
Highest Allowable Overvoltage (Transient Overvoltage, $t_{INI} = 60$ sec)	$V_{TR}$	4000	$V_{PEAK}$
Safety-Limiting Values (Maximum Value Allowed in the Event of a Failure,			
See Thermal Derating Curve, Figure 1			
Case Temperature	$T_{S}$	150	°C
Input Current	I <sub>S, INPUT</sub>	160	mA
Output Current	I <sub>S, OUTPUT</sub>	170	mA
Insulation Resistance at $T_S$ , $V_{IO} = 500 \text{ V}$	Rs	>10 <sup>9</sup>	Ω

This isolator is suitable for basic isolation only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits. The \* marking on the package denotes DIN EN 60747-5-2 approval for 560  $V_{PEAK}$  working voltage.

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 $<sup>^1</sup>$ In accordance with UL 1577, each ADuM1100 is proof tested by applying an insulation test voltage  $\geq 3000$  V rms for 1 second (leakage detection current limit,  $I_{I-O} \leq 5 \mu A$ ).  $^2$ In accordance with DIN EN 60747-5-2, each ADuM1100 is proof tested by applying an insulation test voltage  $\geq 1050$  V<sub>PEAK</sub> for 1 second (partial discharge detection limit  $\leq 5$  pC). A "\*" mark branded on the component designates DIN EN 60747-5-2 approval.

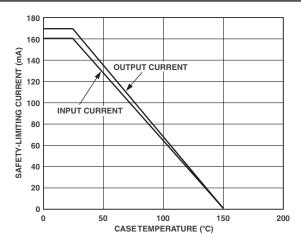


Figure 1. Thermal Derating Curve, Dependence of Safety-Limiting Values with Case Temperature per DIN EN 60747-5-2

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

Parameter	Symbol	Min	Max	Unit
Storage Temperature	$T_{ST}$	-55	+150	°C
Ambient Operating	$T_A$	-40	+125	°C
Temperature				
Supply Voltages <sup>2</sup>	$V_{\mathrm{DD1}}, V_{\mathrm{DD2}}$	-0.5	+6.5	V
Input Voltage <sup>2</sup>	$V_{\rm I}$	-0.5	$V_{\rm DD1} + 0.5$	V
Output Voltage <sup>2</sup>	$V_{O}$	-0.5	$V_{DD2} + 0.5$	V
Average Current, per Pin <sup>3</sup>				
Temperature ≤ 105°C		-25	+25	mA
Temperature ≤ 125°C				
Input Current		-7	+7	mA
Output Current		-20	+20	mA
Common-Mode Transients <sup>4</sup>		-100	+100	kV/μs

#### NOTES

#### RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Operating Temperature				
ADuM1100AR and ADuM1100BR	$T_A$	-40	+105	°C
ADuM1100UR	$T_A$	-40	+125	°C
Supply Voltages <sup>1</sup>	$V_{\mathrm{DD1}}, V_{\mathrm{DD2}}$	3.0	5.5	V
Logic High Input Voltage, 5 V Operation <sup>1, 2</sup> (See TPCs 7 and 8)	$V_{IH}$	2.0	$V_{\mathrm{DD1}}$	V
Logic Low Input Voltage, 5 V Operation <sup>1, 2</sup> (See TPCs 7 and 8)	$V_{IL}$	0.0	0.8	V
Logic High Input Voltage, 3.3 V Operation <sup>1, 2</sup> (See TPCs 7 and 8)	$V_{IH}$	1.5	$V_{\mathrm{DD1}}$	V
Logic Low Input Voltage, 3.3 V Operation <sup>1, 2</sup> (See TPCs 7 and 8)	$V_{IL}$	0.0	0.5	V
Input Signal Rise and Fall Times			1.0	ms

#### NOTES

See the Method of Operation, DC Correctness, and Magnetic Field Immunity section and Figures 8 and 9 for information on immunity to external magnetic fields.

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<sup>&</sup>lt;sup>1</sup> Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only. Functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability. Ambient temperature = 25°C, unless otherwise noted.

<sup>&</sup>lt;sup>2</sup> All voltages are relative to their respective ground.

<sup>&</sup>lt;sup>3</sup> See Figure 1 for information on maximum allowable current for various temperatures.

<sup>&</sup>lt;sup>4</sup> Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the Absolute Maximum Rating may cause latch-up or permanent damage.

<sup>&</sup>lt;sup>1</sup>All voltages are relative to their respective ground.

<sup>&</sup>lt;sup>2</sup>Input switching thresholds have 300 mV of hysteresis.

Table I. Truth Table (Positive Logic)

V <sub>I</sub> Input	V <sub>DD1</sub> State	V <sub>DD2</sub> State	Vo Output
Н	Powered	Powered	Н
L	Powered	Powered	L
X	Unpowered	Powered	H*
X	Powered	Unpowered	X*

<sup>\*</sup> $V_{\rm O}$  returns to  $V_{\rm I}$  state within 1  $\mu s$  of power restoration.

Note: Package branding is as follows:



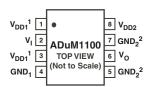
where:

= DIN EN 60747-5-2 mark

R = Package Designator (R denotes SOIC)

YYWW = Date Code XXXXXX = Lot Code

#### PIN CONFIGURATION



NOTES

<sup>1</sup>PIN 1 AND PIN 3 ARE INTERNALLY CONNECTED. EITHER OR BOTH

MAY BE USED FOR V<sub>DD1</sub>.

<sup>2</sup>PIN 5 AND PIN 7 ARE INTERNALLY CONNECTED. EITHER OR BOTH MAY BE USED FOR GND<sub>2</sub>.

#### **ORDERING GUIDE**

Model	Temperature Range	Max Data Rate (Mbps)	Min Pulse Width (ns)	Package Description	Package Option
ADuM1100AR	–40°C to +105°C	25	40	8-Lead SOIC	R-8
ADuM1100AR-RL7	-40°C to $+105$ °C	25	40	8-Lead SOIC, 1,000 Piece Reel	R-8
ADuM1100ARZ*	-40°C to +105°C	25	40	8-Lead SOIC	R-8
ADuM1100ARZ-RL7*	-40°C to $+105$ °C	25	40	8-Lead SOIC, 1,000 Piece Reel	R-8
ADuM1100BR	-40°C to +105°C	100	10	8-Lead SOIC	R-8
ADuM1100BR-RL7	-40°C to +105°C	100	10	8-Lead SOIC, 1,000 Piece Reel	R-8
ADuM1100BRZ*	-40°C to +105°C	100	10	8-Lead SOIC	R-8
ADuM1100BRZ-RL7*	-40°C to +105°C	100	10	8-Lead SOIC, 1,000 Piece Reel	R-8
ADuM1100UR	-40°C to +125°C	100	10	8-Lead SOIC	R-8
ADuM1100UR-RL7	−40°C to +125°C	100	10	8-Lead SOIC, 1,000 Piece Reel	R-8
ADuM1100URZ*	–40°C to +125°C	100	10	8-Lead SOIC	R-8
ADuM1100URZ-RL7*	–40°C to +125°C	100	10	8-Lead SOIC, 1,000 Piece Reel	R-8
ADuM1100EVAL				Evaluation Board	

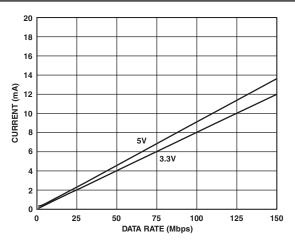
<sup>\*</sup>Z = Lead Free

#### CAUTION.

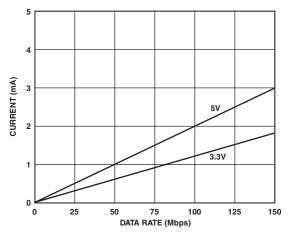
ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADuM1100 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



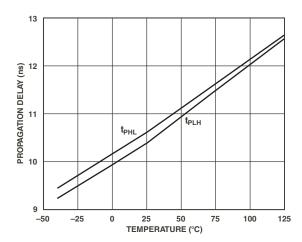
# **Typical Performance Characteristics—ADuM1100**



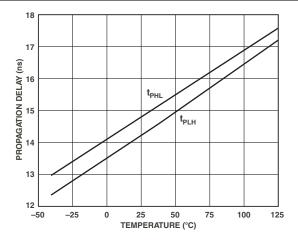
TPC 1. Typical Input Supply Current vs. Logic Signal Frequency for 5 V and 3.3 V Operation



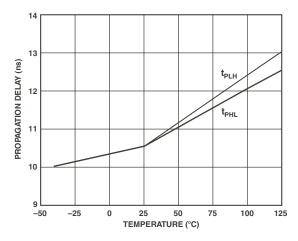
TPC 2. Typical Output Supply Current vs. Logic Signal Frequency for 5 V and 3.3 V Operation



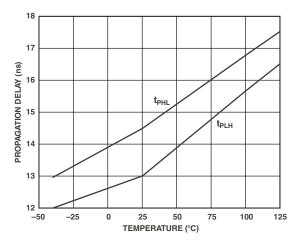
TPC 3. Typical Propagation Delays vs. Temperature, 5 V Operation



TPC 4. Typical Propagation Delays vs. Temperature, 3.3 V Operation

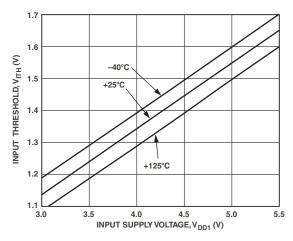


TPC 5. Typical Propagation Delays vs. Temperature, 5 V/3 V Operation

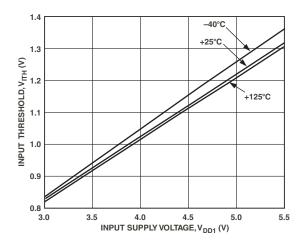


TPC 6. Typical Propagation Delays vs. Temperature, 3 V/5 V Operation

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TPC 7. Typical Input Voltage Switching Threshold, Low-to-High Transition



TPC 8. Typical Input Voltage Switching Threshold, High-to-Low Transition

#### APPLICATION INFORMATION

#### **PC Board Layout**

The ADuM1100 digital isolator requires no external interface circuitry for the logic interfaces. A bypass capacitor is recommended at the input and output supply pins. The input bypass capacitor may most conveniently be connected between Pins 3 and 4 (Figure 2). Alternatively, the bypass capacitor may be located between Pins 1 and 4. The output bypass capacitor may be connected between Pins 7 and 8 or Pins 5 and 8. The capacitor value should be between 0.01  $\mu F$  and 0.1  $\mu F$ . The total lead length between both ends of the capacitor and the power supply pins should not exceed 20 mm.

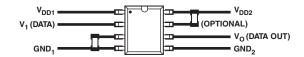


Figure 2. Recommended Printed Circuit Board Layout

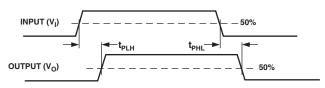


Figure 3. Propagation Delay Parameters

#### **Propagation Delay-Related Parameters**

Propagation delay time describes the length of time it takes for a logic signal to propagate through a component. Propagation delay

time to logic low output and propagation delay time to logic high output refer to the duration between an input signal transition and the respective output signal transition (Figure 3).

Pulse width distortion is the maximum difference between  $t_{PLH}$  and  $t_{PHL}$  and provides an indication of how accurately the input signal's timing is preserved in the component's output signal. Propagation delay skew is the difference between the minimum and maximum propagation delay values among multiple ADuM1100 components operated at the same operating temperature and having the same output load.

Depending on the input signal rise/fall time, the measured propagation delay based on the input 50% level can vary from the true propagation delay of the component (as measured from its input switching threshold). This is due to the fact that the input threshold, as is the case with commonly used optocouplers, is at a different voltage level than the 50% point of typical input signals. This propagation delay difference is given by

$$\Delta_{LH} = t'_{PLH} - t_{PLH} = (t_r / 0.8V_I)(0.5V_1 - V_{ITH(L-H)})$$

$$\Delta_{HL} = t'_{PHL} - t_{PHL} = (t_f / 0.8V_I)(0.5V_1 - V_{ITH(H-L)})$$

where:

 $t_{PLH}$ ,  $t_{PHL}$  = propagation delays as measured from the input 50% level.

 $t'_{PLH}$ ,  $t'_{PHL}$  = propagation delays as measured from the input switching thresholds.

 $t_r$ ,  $t_f$  = input 10% to 90% rise/fall time.

 $V_I$  = amplitude of input signal (0 to  $V_I$  levels assumed).

 $V_{ITH(L-H)}$ ,  $V_{ITH(H-L)}$  = input switching thresholds.

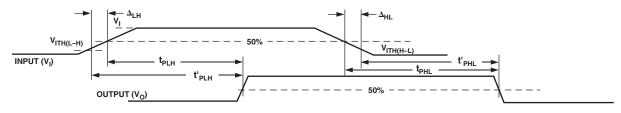


Figure 4. Impact of Input Rise/Fall Time on Propagation Delay

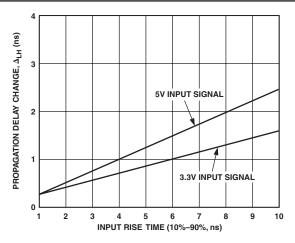


Figure 5. Typical Propagation Delay Change due to Input Rise Time Variation (for  $V_{DD1} = 3.3 \text{ V}$  and 5 V)

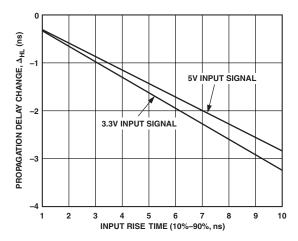


Figure 6. Typical Propagation Delay Change due to Input Fall Time Variation (for  $V_{DD1} = 3.3 \text{ V}$  and 5 V)

The impact of the slower input edge rates can also affect the measured pulse width distortion as based on the input 50% level. This impact may either increase or decrease the apparent pulse width distortion depending on the relative magnitudes of  $t_{PHL}$ ,  $t_{PLH}$ , and PWD. The case of interest here is the condition that leads to the largest increase in pulse width distortion. The change in this case is given by

$$\begin{split} &\Delta_{PWD} = PWD' - PWD = \Delta_{LH} - \Delta_{HL} = \\ &\left(t/0.8V_1\right) \left(V - V_{ITH\left(L-H\right)} - V_{ITH\left(H-L\right)}\right), \left(for \ t = t_r = t_f\right) \end{split}$$

where:

$$PWD = \left| t_{PLH} - t_{PHL} \right|$$

$$PWD' = \left| t'_{PLH} - t'_{PHL} \right|$$

This adjustment in pulse width distortion is plotted as a function of input rise/fall time in Figure 7.

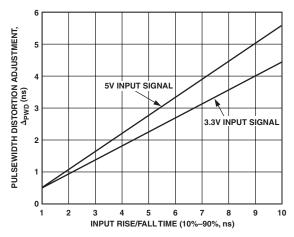


Figure 7. Typical Pulse Width Distortion Adjustment due to Input Rise/Fall Time Variation (at  $V_{DD1} = 3.3 \text{ V}$  and 5 V)

# Method of Operation, DC Correctness, and Magnetic Field Immunity

Referring to the functional block diagram, the two coils act as a pulse transformer. Positive and negative logic transitions at the isolator input cause narrow (2 ns) pulses to be sent via the transformer to the decoder. The decoder is bistable and therefore either set or reset by the pulses indicating input logic transitions. In the absence of logic transitions at the input for more than 2  $\mu s$ , a periodic update pulse of the appropriate polarity is sent to ensure dc correctness at the output. If the decoder receives none of these update pulses for more than about 5  $\mu s$ , the input side is assumed to be unpowered or nonfunctional, in which case the isolator output is forced to a logic high state by the watchdog timer circuit.

The limitation on the ADuM1100's magnetic field immunity is set by the condition in which induced voltage in the transformer's receiving coil is sufficiently large to either falsely set or reset the decoder. The analysis that follows defines the conditions under which this may occur. The ADuM1100's 3.3 V operating condition is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output are greater than 1.0 V in amplitude. The decoder has sensing thresholds at about 0.5 V, therefore establishing a 0.5 V margin in which induced voltages can be tolerated. The induced voltage induced across the receiving coil is given by

$$V = (-d\beta/dt) \Sigma \pi r_n^2; n = 1, 2, \dots, N$$

where:

 $\beta$  = magnetic flux density (Gauss).

N = number of turns in receiving coil.

 $r_n$  = radius of nth turn in receiving coil (cm).

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Given the geometry of the receiving coil in the ADuM1100 and an imposed requirement that the induced voltage be at most 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated as shown in Figure 8.

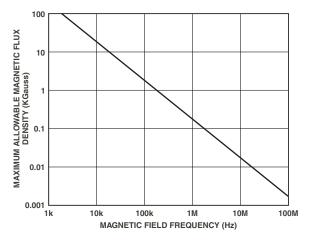


Figure 8. Maximum Allowable External Magnetic Field

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 KGauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and will not cause a faulty output transition. Similarly, if such an event were to occur during a transmitted pulse (and was of the worst-case polarity), it would reduce the received pulse from >1.0 V to 0.75 V—still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances away from the ADuM1100 transformers. Figure 9 expresses these allowable current magnitudes as a function of frequency for selected distances. As can be seen, the ADuM1100 is extremely immune and can be affected only by extremely large currents operated at high frequency and very close to the component. For the 1 MHz example noted, one would have to place a current of 0.5 kA 5 mm away from the ADuM1100 to affect the component's operation.

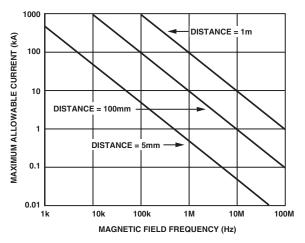


Figure 9. Maximum Allowable Current for Various Current-to-ADuM1100 Spacings

Note that at combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces could induce sufficiently large error voltages to trigger the thresholds of succeeding circuitry. Care should be taken in the layout of such traces to avoid this possibility.

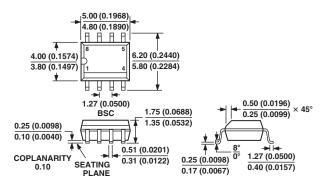
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#### **OUTLINE DIMENSIONS**

#### 8-Lead Standard Small Outline Package [SOIC] Narrow Body

(R-8)

Dimensions shown in millimeters and (inches)



COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

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# **Revision History**

Location Page
10/03—Data Sheet changed from REV. D to REV. E.
Changes to Product Name
Changes to FEATURES
Changes to GENERAL DESCRIPTION
Changes to REGULATORY INFORMATION
Changes to DIN EN 60747-5-2 (VDE 0884 Part 2) INSULATION CHARACTERISTICS
Changes to ABSOLUTE MAXIMUM RATINGS
Changes to RECOMMENDED OPERATING CONDITIONS
Changes to ORDERING GUIDE
6/03—Data Sheet changed from REV. C to REV. D.
Changed DIN EN 60747-5-2 (VDE 0884 Part 2) INSULATION CHARACTERISTICS
Updated ORDERING GUIDE8
Updated OUTLINE DIMENSIONS
4/03—Data Sheet changed from REV. B to REV. C.
Changes to FEATURES
Changes to Patent note
Changes to REGULATORY INFORMATION
Changes to INSULATION CHARACTERISTICS section
Changes to ABSOLUTE MAXIMUM RATINGS
Changes to Package Branding
Changes to Method of Operation, DC Correctness, and Magnetic Field Immunity section
Replaced Figure 9
1/03—Data Sheet changed from REV. A to REV. B.
Added ADuM1100UR Grade
Changed ADuM1100AR/ADuM1100BR to ADuM1100
Changes to FEATURES
Changes to GENERAL DESCRIPTION
Changes to SPECIFICATIONS
Added Electrical Specifications, Mixed 5 V/3 V or 3 V/5 V Operation table
Updated REGULATORY INFORMATION
Changes to VDE 0884 INSULATION CHARACTERISTICS
Changes to ABSOLUTE MAXIMUM RATINGS
Changes to Package Branding
Updated TPCs 3–8
Deleted <i>i</i> Coupler in Field Bus Networks section
Changes to Figure 8
Added a new Figure 9 and related text
11/02—Data Sheet changed from REV. 0 to REV. A.
Edits to FEATURES
Edits to REGULATORY INFORMATION
Edits to VDE 0884 INSULATION CHARACTERISTICS
Added Revision History
Updated OUTLINE DIMENSIONS

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